IXYS

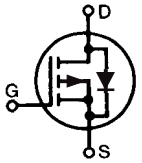
Preliminary Technical Information

TrenchP™ Power MOSFET

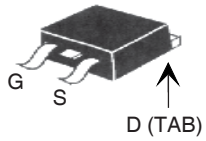
IXTA24P085T
IXTP24P085T

V_{DSS} = - 85V
I_{D25} = - 24A
$R_{DS(on)}$ ≤ 65mΩ

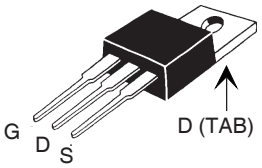
P-Channel Enhancement Mode
Avalanche Rated



TO-263 (IXTA)



TO-220 (IXTP)



G = Gate D = Drain
S = Source TAB = Drain

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	T_J = 25°C to 150°C	- 85	V
V_{DGR}	T_J = 25°C to 150°C, R_{GS} = 1MΩ	- 85	V
V_{GSS}	Continuous	±20	V
V_{GSM}	Transient	±30	V
I_{D25}	T_C = 25°C	- 24	A
I_{DM}	T_C = 25°C, pulse width limited by T_{JM}	- 80	A
I_{AR}	T_C = 25°C	- 24	A
E_{AS}	T_C = 25°C	200	mJ
P_D	T_C = 25°C	83	W
T_J		-55 ... +150	°C
T_{JM}		150	°C
T_{stg}		-55 ... +150	°C
T_L	1.6mm (0.062 in.) from case for 10s	300	°C
T_{SOLD}	Plastic body for 10s	260	°C
M_d	Mounting torque (TO-220)	1.13/10	Nm/lb.in.
Weight	TO-220	3.0	g
	TO-263	2.5	g

Symbol	Test Conditions (T_J = 25°C, unless otherwise specified)	Characteristic Values Min.	Typ.	Max.	
BV_{DSS}	V_{GS} = 0V, I_D = - 250μA	- 85			V
$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250μA	- 2.5		- 4.5	V
I_{GSS}	V_{GS} = ± 20V, V_{DS} = 0V			±50	nA
I_{DSS}	V_{DS} = V_{DSS}			- 3	μA
	V_{GS} = 0V T_J = 125°C			-100	μA
$R_{DS(on)}$	V_{GS} = -10V, I_D = 0.5 • I_{D25}, Note 1			65	mΩ

Features

- International standard packages
- Fast intrinsic diode
- Avalanche Rated
- Low Q_G and $R_{ds(on)}$
- Extended FBSOA

Applications

- Load Switches
- Hight side switches
- Low voltage applications such as automotive, DC/DC converters
- High efficiency switching power supplies for portable and battery operated systems
- Inverters and battery chargers
- Audio and Medical applications

Advantages

- Low gate charge results in simple drive requirement
- High power density
- Fast switching

Symbol	Test Conditions (T_J = 25°C, unless otherwise specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	V_{DS} = -10V, I_D = 0.5 • I_{D25}, Note 1	10	16		S
C_{iss}	V_{GS} = 0V, V_{DS} = - 25V, f = 1MHz		2090		pF
C_{oss}			243		pF
C_{rss}			117		pF
$t_{d(on)}$	**Resistive Switching Times**		18		ns
t_r	V_{GS} = -10V, V_{DS} = 0.5 • V_{DSS}, I_D = 0.5 • I_{D25}		26		ns
$t_{d(off)}$	R_G = 10Ω (External)		53		ns
t_f			26		ns
$Q_{g(on)}$	V_{GS} = -10V, V_{DS} = 0.5 • V_{DSS}, I_D = 0.5 • I_{D25}		41		nC
Q_{gs}			17		nC
Q_{gd}			11		nC
R_{thJC}				1.5	°C/W
R_{thCS}	(TO-220)		0.50		°C/W

Source-Drain Diode

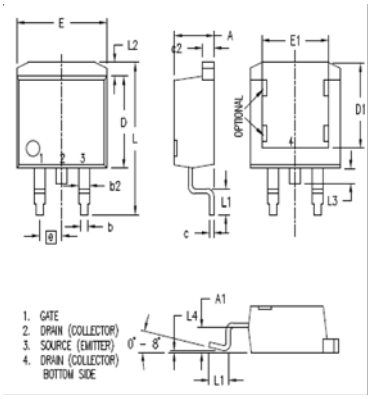
Symbol	Test Conditions (T_J = 25°C, unless otherwise specified)	Characteristic Values Min.	Typ.	Max.	
I_S	V_{GS} = 0V			- 24	A
I_{SM}	Repetitive, pulse width limited by T_{JM}			- 96	A
V_{SD}	I_F = - 24A, V_{GS} = 0V, Note 1			-1.5	V
t_{rr}	I_F = -12A, -di/dt = -100A/μs		40		ns
Q_{RM}	V_R = - 43V, V_{GS} = 0V		72		nC
I_{RM}			- 3.6		A

Note 1: Pulse test, t ≤ 300μs; duty cycle, d ≤ 2%.

PRELIMINARY TECHNICAL INFORMATION

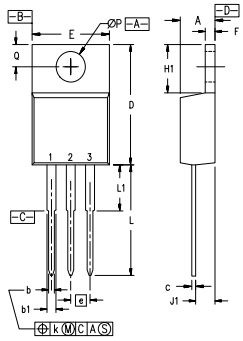
The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

TO-263 (IXTA) Outline



SYM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	.160	.190	4.06	4.83
A1	.080	.110	2.03	2.79
b	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
c	.016	.029	0.40	0.74
c2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
E	.380	.410	9.65	10.41
E1	.245	.320	6.22	8.13
e	.100 BSC		2.54 BSC	
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13

TO-220 (IXTP) Outline



Pins: 1 - Gate 2 - Drain
3 - Source 4 - Drain

SYM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	.170	.190	4.32	4.83
b	.025	.040	0.64	1.02
b1	.045	.065	1.15	1.65
c	.014	.022	0.35	0.56
D	.580	.630	14.73	16.00
E	.390	.420	9.91	10.66
e	.100 BSC		2.54 BSC	
F	.045	.055	1.14	1.40
H1	.230	.270	5.85	6.85
J1	.090	.110	2.29	2.79
k	0	.015	0	0.38
L	.500	.550	12.70	13.97
L1	.110	.230	2.79	5.84
ØP	.139	.161	3.53	4.08
Q	.100	.125	2.54	3.18

Fig. 1. Output Characteristics @ 25ºC

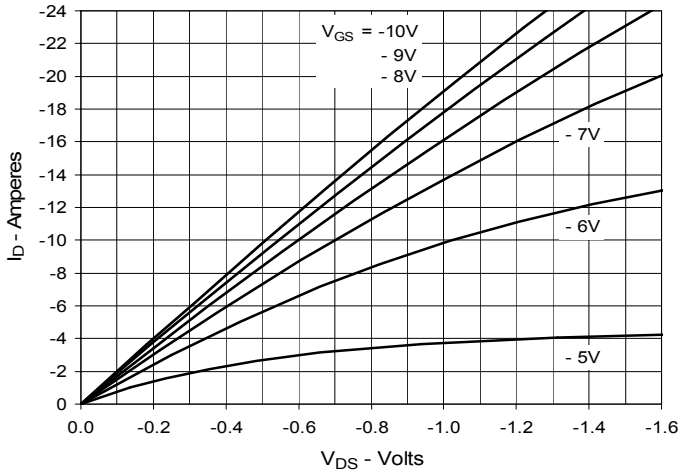


Fig. 2. Extended Output Characteristics @ 25ºC

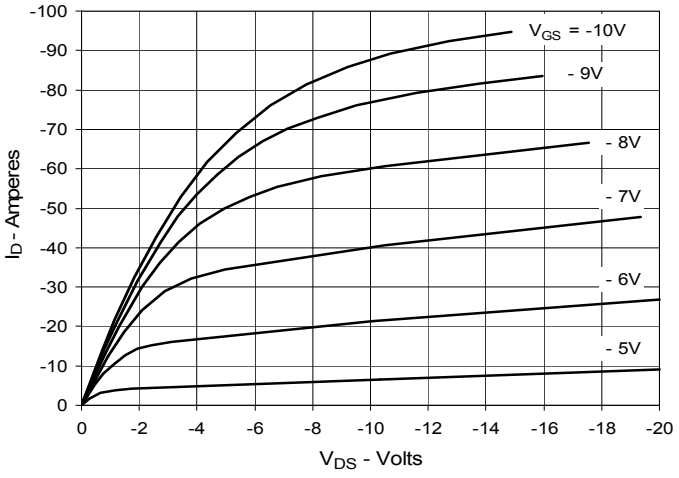


Fig. 3. Output Characteristics @ 125ºC

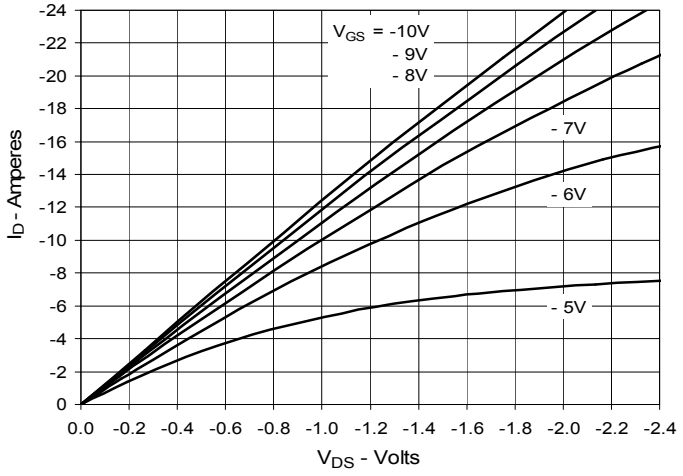


Fig. 4. $R_{DS(on)}$ Normalized to I_D = -12A vs. Junction Temperature

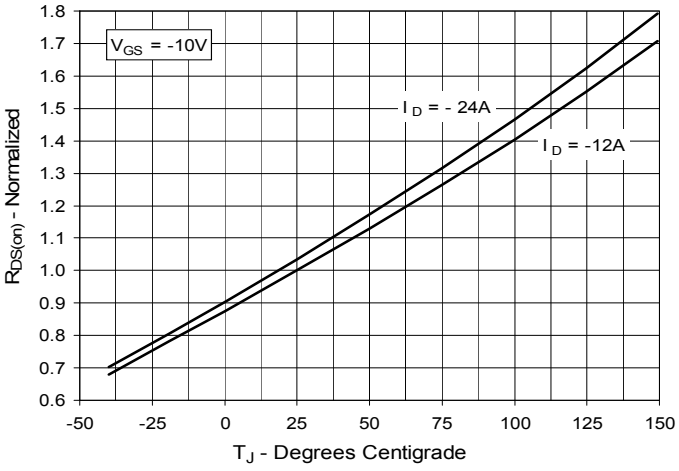


Fig. 5. $R_{DS(on)}$ Normalized to I_D = -12A vs. Drain Current

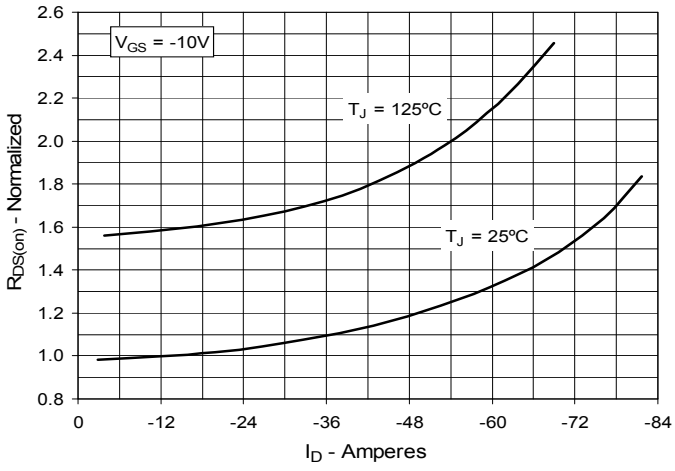


Fig. 6. Maximum Drain Current vs. Case Temperature

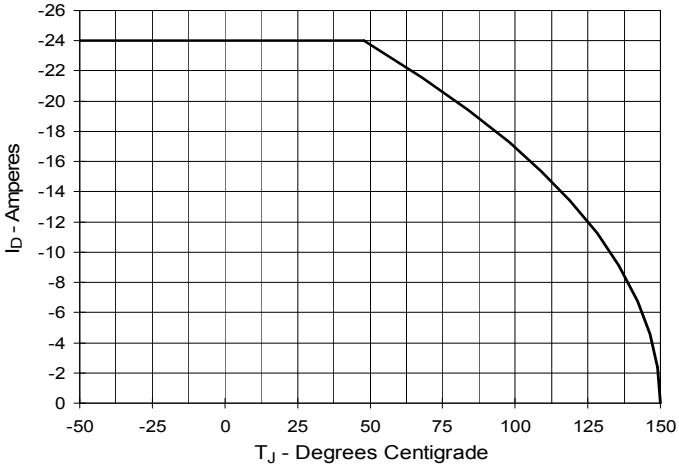


Fig. 7. Input Admittance

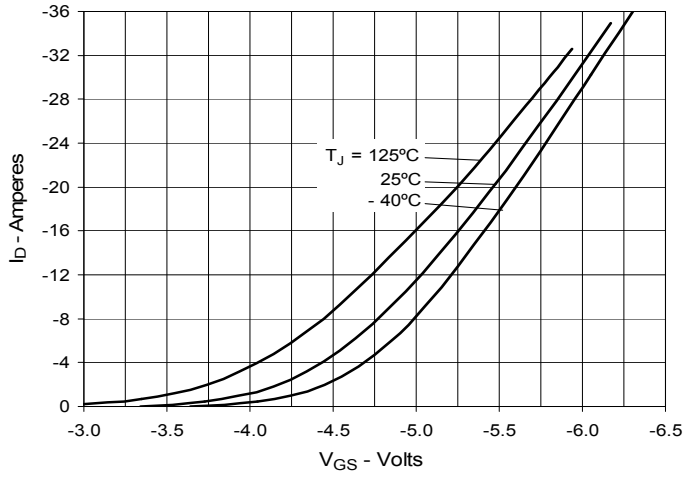


Fig. 8. Transconductance

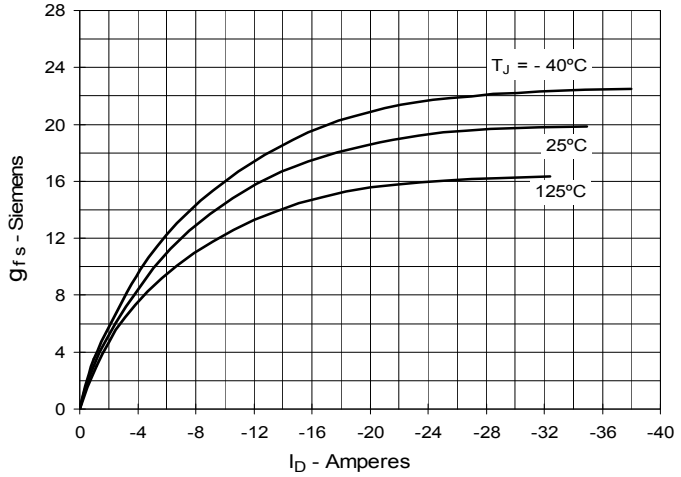


Fig. 9. Forward Voltage Drop of Intrinsic Diode

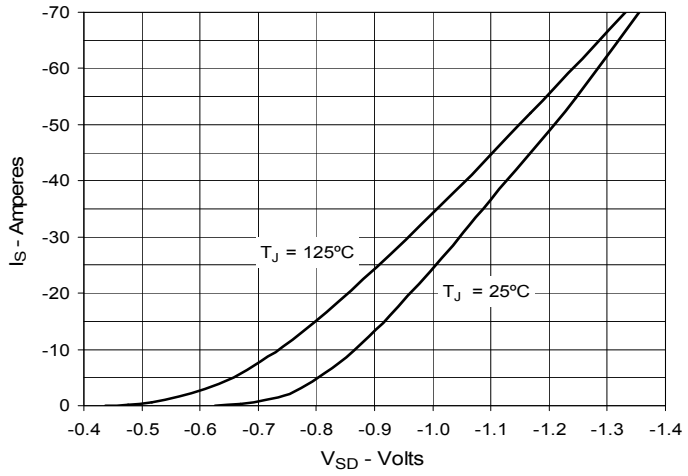


Fig. 10. Gate Charge

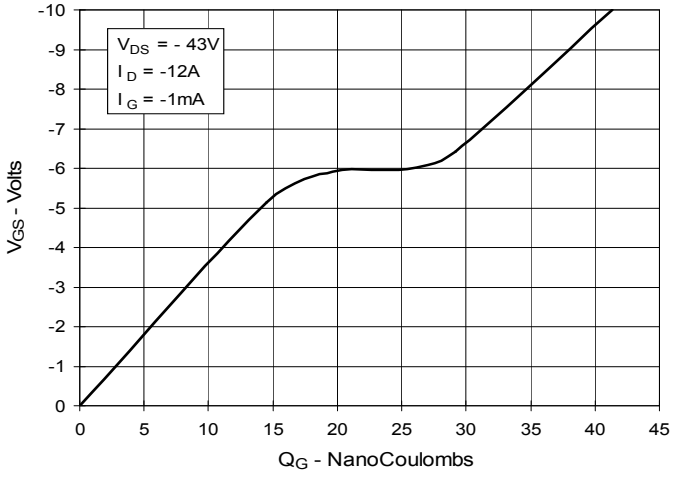


Fig. 11. Capacitance

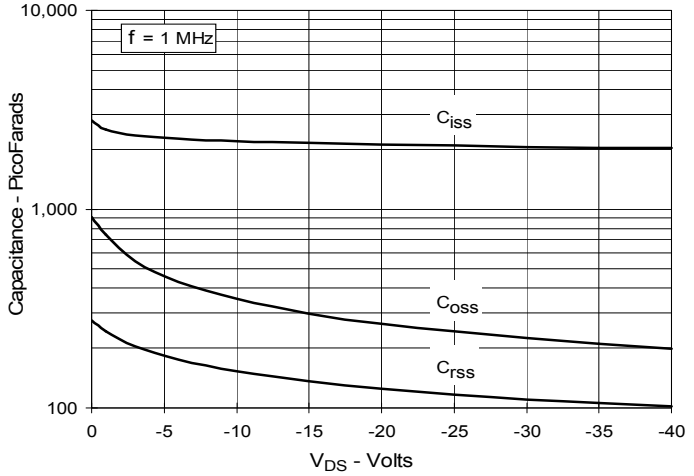


Fig. 12. Forward-Bias Safe Operating Area

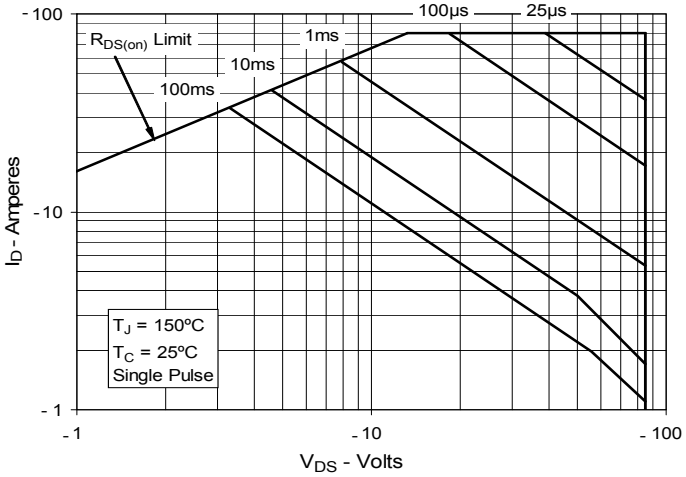


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

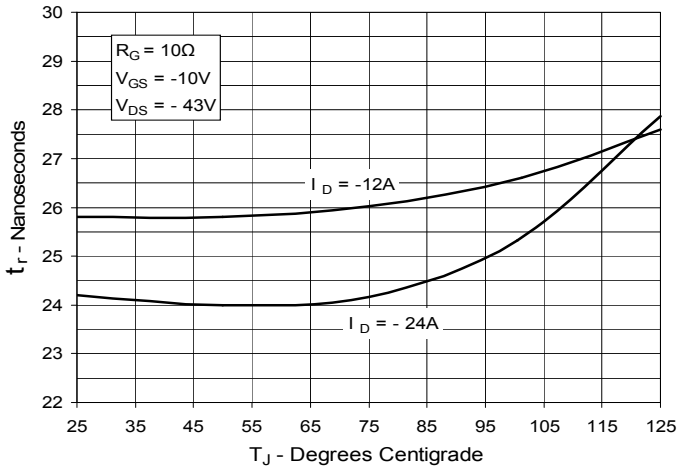


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

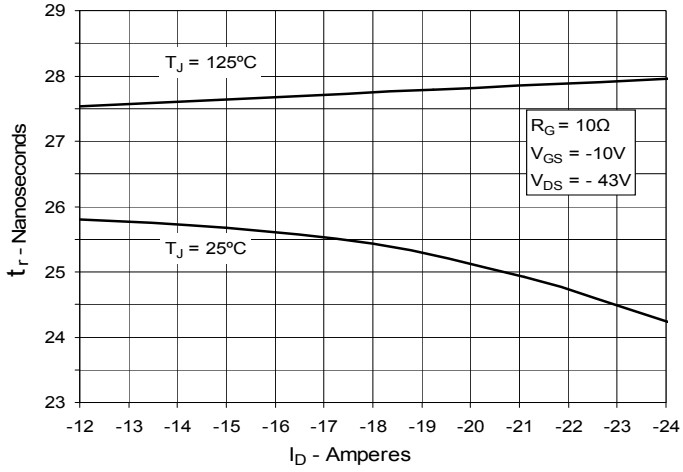


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

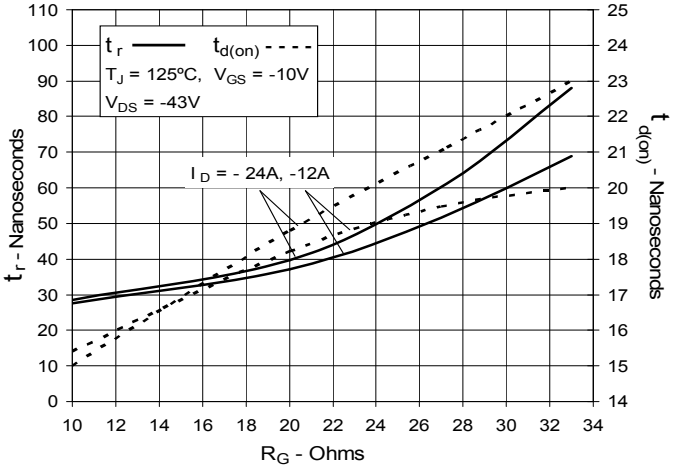


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

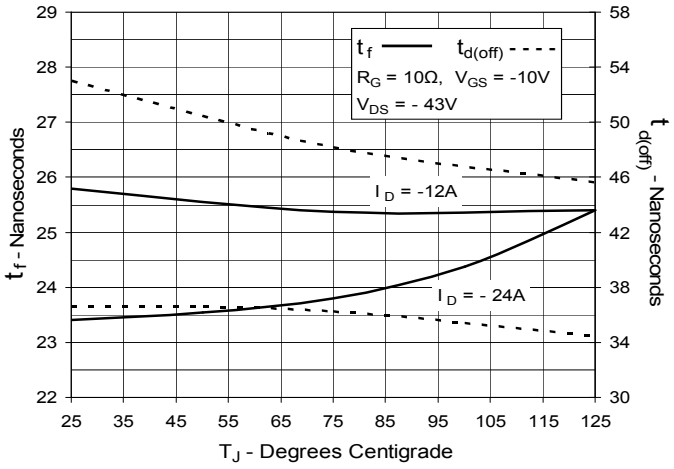


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

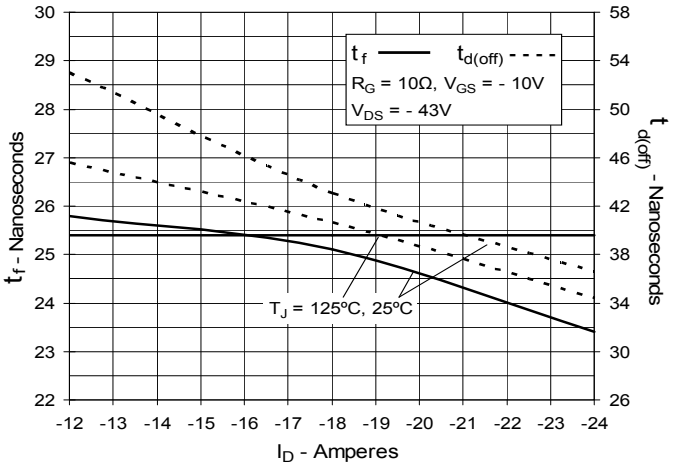


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance

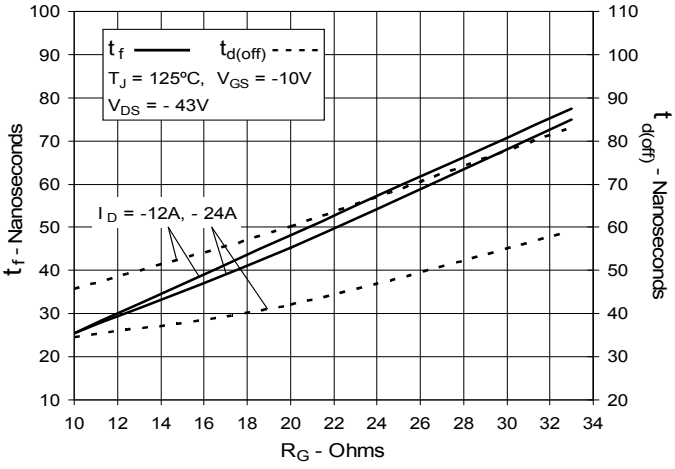


Fig. 19. Maximum Transient Thermal Impedance